

FDMS0312AS N-Channel PowerTrench[®] SyncFETTM 30 V, 22 A, 5.0 m Ω

Features

- Max $r_{DS(on)} = 5.0 \text{ m}\Omega \text{ at } V_{GS} = 10 \text{ V}, I_D = 18 \text{ A}$
- Max $r_{DS(on)} = 6.2 \text{ m}\Omega \text{ at } V_{GS} = 4.5 \text{ V}, I_D = 16 \text{ A}$
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- SyncFET Schottky Body Diode
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

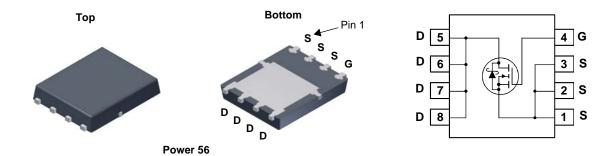


General Description

The FDMS0312AS has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest $r_{DS(on)}$ while maintaining excellent switching performance.This device has the added benefit of an efficient monolithic Schottky body diode.

Applications

- Synchronous Rectifier for DC/DC Converters
- Notebook Vcore/GPU low side switch
- Networking Point of Load low side switch
- Telecom secondary side rectification



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			30	V	
V _{GS}	Gate to Source Voltage		(Note 4)	±20	V	
ID	Drain Current -Continuous (Package limited)	$T_C = 25^{\circ}C$		22	70	
	-Continuous (Silicon limited)	$T_C = 25^{\circ}C$		70		
	-Continuous	T _A = 25°C	(Note 1a)	18	Α	
	-Pulsed		100	_		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	33	mJ	
P _D	Power Dissipation	T _C = 25°C		36	14/	
	Power Dissipation	$T_A = 25^{\circ}C$	(Note 1a)	2.5	W	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

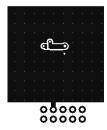
$R_{\theta JC}$	Thermal Resistance, Junction to Case	3.4	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1	a) 50	C/VV

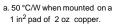
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS0312AS	FDMS0312AS	Power 56	13 "	12 mm	3000 units

October 2014

Symbol	Parameter	s otherwise noted Test Conditions	Min	Тур	Max	Units
Off Chara	octeristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 1 mA, V _{GS} = 0 V	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 10$ mA, referenced to 25°C		18		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 24 V, V _{GS} = 0 V			500	μA
I _{GSS}	Gate to Source Leakage Current, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
	cteristics	00 20				
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 1 \text{ mA}$	1.2	1.5	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{J}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 10$ mA, referenced to 25°C		-4		mV/°C
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 18 A		4.2	5.0	
		$V_{GS} = 4.5 \text{ V}, I_D = 16 \text{ A}$		5.4	6.2	mΩ
		$V_{GS} = 10 \text{ V}, I_D = 18 \text{ A}, T_J = 125^{\circ}\text{C}$		5.3	6.8	-
9 _{FS}	Forward Transconductance	$V_{DS} = 5 V, I_{D} = 18 A$		92		S
C _{oss} C _{rss}	Output Capacitance Reverse Transfer Capacitance	V _{DS} = 15 V, V _{GS} = 0 V, f = 1MHz		550 70	730 105	pF pF
						•
R _g	Gate Resistance			0.5	2.5	Ω
Switching	g Characteristics					1
t _{d(on)}	Turn-On Delay Time			10	19	ns
t _r	Rise Time	$V_{DD} = 15 \text{ V}, \text{ I}_{D} = 18 \text{ A},$		2.3	10	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		25	40	ns
t _f	Fall Time			6	12	ns
Q _g	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$		23 11	31 16	nC
Q _g	Total Gate Charge Gate to Source Charge	$V_{GS} = 0 V \text{ to } 4.5 V$ $V_{DD} = 15 V,$ $I_{D} = 18 A$		3.3	10	nC nC
Q _{gs}	Gate to Drain "Miller" Charge			3.3		nC
Q _{gd}				5.7		no
Jrain-Sol	urce Diode Characteristics					
Ver	Source-Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.63	0.8	v
Ven		$V_{GS} = 0 V, I_S = 18 A$ (Note 2)		0.8	1.2	
V _{SD}				00	20	00
V _{SD} t _{rr} Q _{rr}	Reverse Recovery Time Reverse Recovery Charge	I _F = 18 A, di/dt = 300 A/μs		23 20	36 32	ns nC

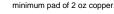


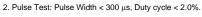




00000

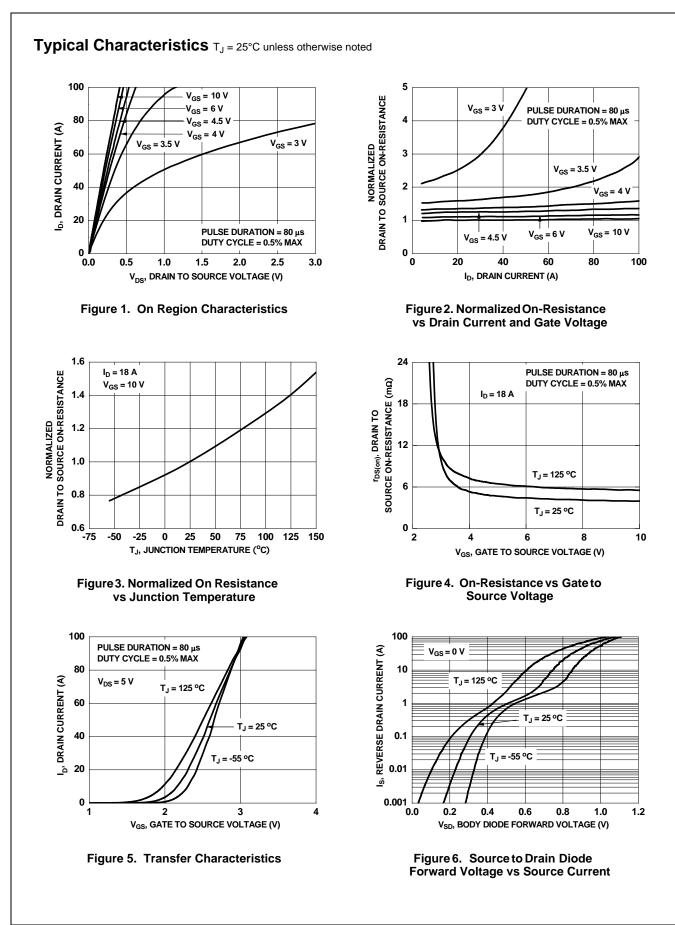
b. 125 °C/W when mounted on a minimum pad of 2 oz copper.

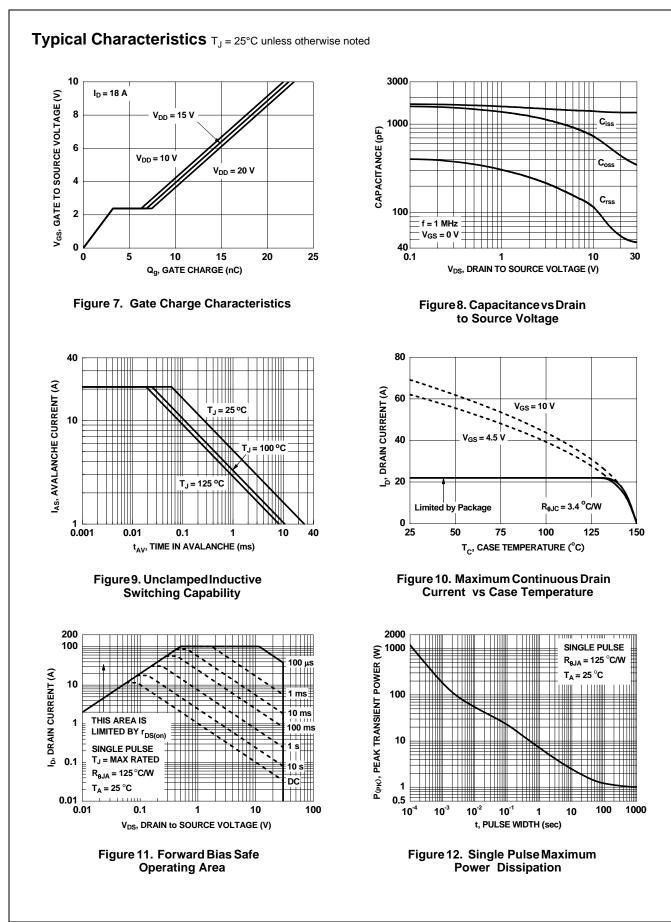


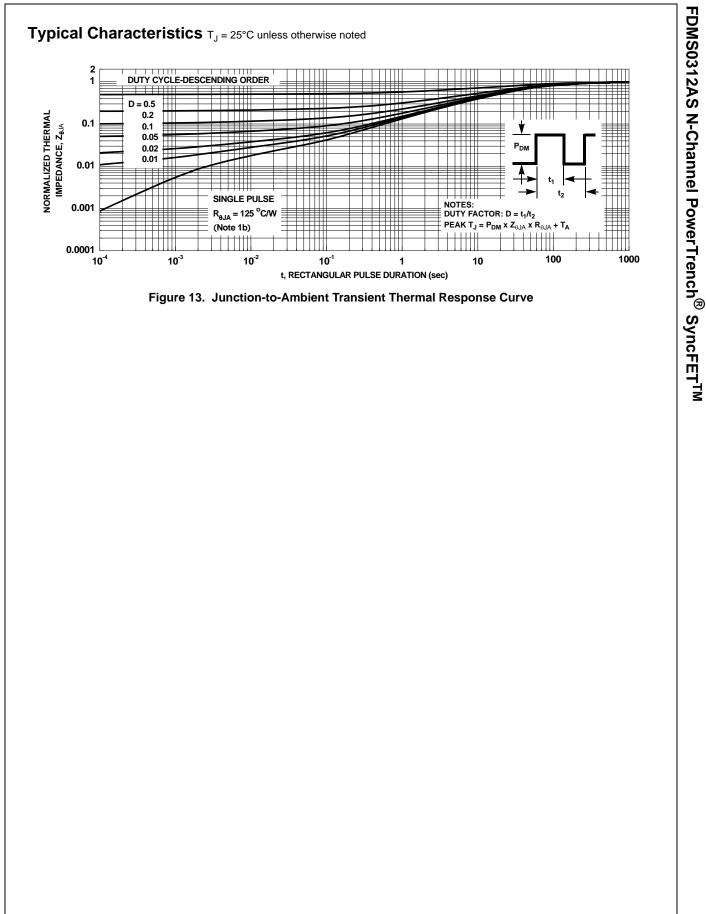


3. E_{AS} of 33 mJ is based on starting T_J = 25 °C, L = 0.3 mH, I_{AS} = 15 A, V_{DD} = 27 V, V_{GS} = 10 V.

4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.







Typical Characteristics (continued)

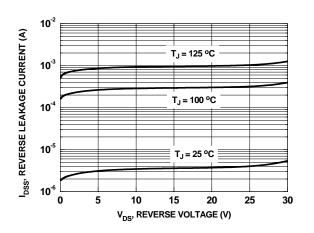
SyncFET Schottky body diode Characteristics

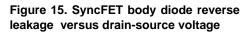
Fairchild's SyncFET process embeds a Schottky diode in parallel with PowerTrench MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverse recovery characteristic of the FDMS0312AS.

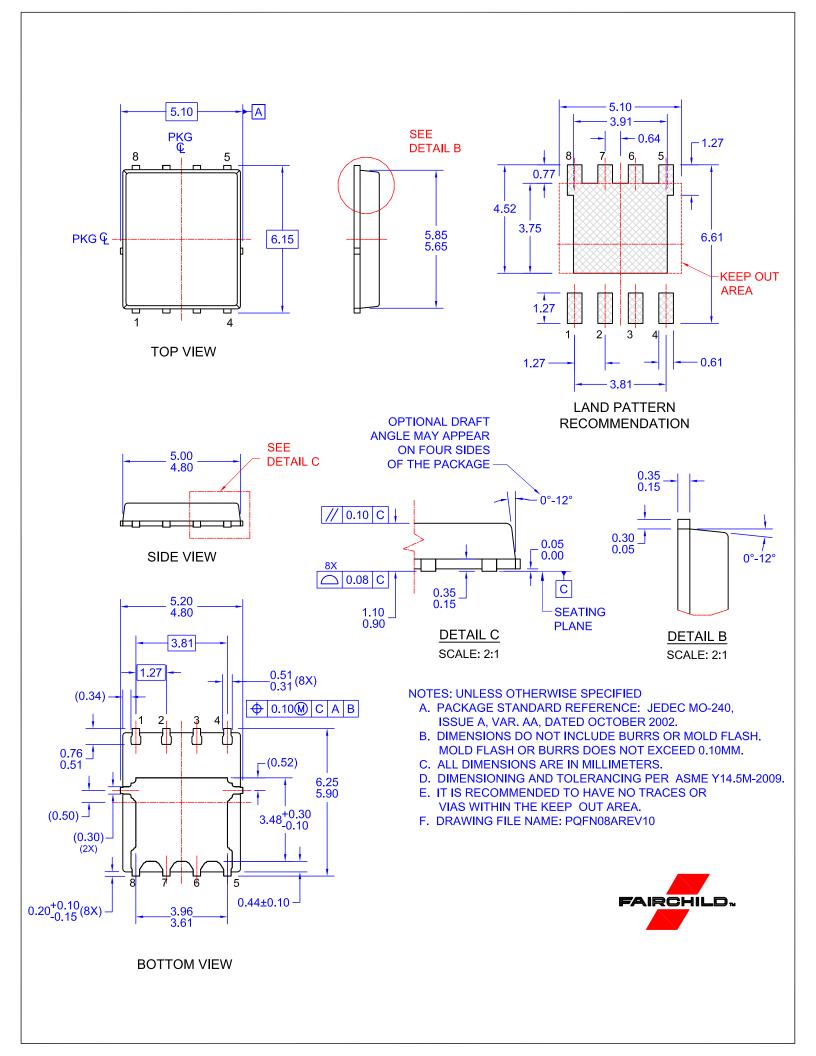
25 20 10 10 5 0 -5 10 20 30 40 50 TIME (ns)

Figure 14. FDMS0312AS SyncFET body diode reverse recovery characteristic

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.









* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. TO OBTAIN THE LATEST, MOST UP-TO-DATE DATASHEET AND PRODUCT INFORMATION, VISIT OUR WEBSITE AT <u>HTTP://WWW.FAIRCHILDSEMI.COM</u>, FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

AUTHORIZED USE

Unless otherwise specified in this data sheet, this product is a standard commercial product and is not intended for use in applications that require extraordinary levels of quality and reliability. This product may not be used in the following applications, unless specifically approved in writing by a Fairchild officer: (1) automotive or other transportation, (2) military/aerospace, (3) any safety critical application – including life critical medical equipment – where the failure of the Fairchild product reasonably would be expected to result in personal injury, death or property damage. Customer's use of this product is subject to agreement of this Authorized Use policy. In the event of an unauthorized use of Fairchild's product, Fairchild accepts no liability in the event of product failure. In other respects, this product shall be subject to Fairchild's Worldwide Terms and Conditions of Sale, unless a separate agreement has been signed by both Parties.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Terms of Use

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms				
Datasheet Identification	Product Status	Definition		
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.		

Rev. 177

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Fairchild Semiconductor: FDMS0312AS